



Materials Declaration Form

IPC Form Type *	1752 Distribute	Version	2
Sectionals *	Material Info Manufacturing Info	Subsectionals *	A-D

** : Required Field*

Supplier Information			
Company Name *	STMicroelectronics	Response Date *	2020-02-03
Company Unique ID	NL 008751171B01		
Contact Name *	Refer to Supplier Comment section		Refer to Supplier Comment section
Contact Phone *	Refer to Supplier Comment section	Contact Email *	Refer to Supplier Comment section
Authorized Representative *	Floriana SAN BIAGIO	Representative Title	AMS MD CHAMPION
Representative Phone *	Refer to Supplier Comment section	Representative Email *	Refer to Supplier Comment section
Supplier Comment	Online Technical Support - STMicroelectronics : http://www.st.com/web/en/support/support.html		

Uncertainty Statement


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Legal Statement		
Supplier Acceptance *	true	Legal Declaration *
		Standard

Legal Statement

Supplier certifies that it gathered the provided information and such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.

Product				
Mfr Item Number	Mfr Item Name	Version	Mfr Site	Date
	RRVV*UI69AC5	A	999L-Z9LA	2020-02-03
Amount	UoM	Unit type	ST ECOPACK Grade	
16	mg	Each	ECOPACK® 2	
Comment	ECOPACK® 2 is STMicroelectronics trade name for ROHS compliant device without Brominated and Chlorinated compound (900ppm) and without Antimony oxide flame retardant (in each organic material)			

Manufacturing information				
J-STD-020 MSL Rating	Classification Temp	Nbr of Reflow Cycles		
1	260	3	 life.augmented	
Bulk Solder Termination	Terminal Plating	Terminal Base Alloy		
Not Applicable	Tin (Sn), matte, annealed	Copper Alloy	0	

Package Designator	Size	Nbr of instances	Shape	
SOT	2.8 x 1.5	23	gull wing	
Comment	WV SOT 23 5L; MDF is valid for LDK120M-R and LDK130M-R			

QueryList : RoHS Directive 2011/65/EU-July 2011 – Annex II amended by Directive 2015/863-March 2015				
Query				Response
1 - Product(s) meets EU RoHS requirement without any exemptions				TRUE
2 - Product(s) meets EU RoHS requirements except lead in solder and this usage may qualify under the lead in solder '7b' exemption (other selected exemptions may apply)				FALSE
3 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)				FALSE
4 - Product(s) does not meet EU RoHS requirements and is not under exemptions				FALSE
Exemption Id.	Description			

QueryList : ELV directive : 2000/53/EC amended 2017/2096 _November 2017				
Query				Response
1 - Product(s) meets EU ELV requirements without any exemptions				TRUE
2 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)				FALSE
Exemption Id.	Description			

QueryList : California Prop65 list, dated 3rd January 2020				
Query				Response
1 - The product does not contain identified substance from California Prop 65 List, no exposure to consumers is foreseen				TRUE
2 - The product is containing below substance(s) from California Prop 65 List, no exposure to consumers is foreseen				FALSE
Substance	amount in product (mg)	Application	ppm in product	

QueryList : Chinese RoHS , references : SJT 11364 – 2014 and GBT 26572 – 2014				
Query				Response
1 - Product(s) requires marking for the presence of restricted substances and must be marked with an Environmental Protection Use Period under China's Measures for Administration of the control of pollution by Electronic Information Products				FALSE
2 - Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products				FALSE
Hasardous substance				
Lead (Pb)	Cadmium (Cd)	Mercury (Hg)	Hexavalent Chromium (Cr VI)	PBB & PBDE

QueryList : REACH-16th January 2020				
Query				Response
1 - Product(s) does not contain REACH Substances Of Very High Concern above the limits per the definition within REACH				TRUE
CategoryLevel_Name	CategoryLevel_Threshold	amount in product (mg)	Application	ppm in product
2 - Product(s) does not contain REACH Substances Of Very High Concern in any Embedded article nor Homogeneous Material above the limits per the definition within REACH				TRUE
CategoryLevel_Name	CategoryLevel_Threshold	Amount in Embedded Article / Homogeneous Material (mg)	Application - Article / Homogeneous Material	ppm in Article /Homogeneous Material

QueryList : Korea Chemical Control Act_ 27 Dec 2017 update				
Query				Response
The Product does contain at least one of the substances listed in Chemical Control Act				NO
Substance	Homogeneous Material impacted	Content in Homogeneous Material (mg)	Concentration in the material(%)	Application Purpose

Material Composition Declaration :						Mfr Item Name	RRWV*UI69AC5			6000000.0	999632.0	
note : Substance present with less 0.001mg will not be declared in this document												
Homogeneous Material	Material Group	Mass	UoM	Level	Substance Category	Substance	CAS	Exempt	Mass	UoM	Concentration in homogeneous material (ppm)	Concentration in product (ppm)
Die	M-011 Other inorganic materials	0.283	mg	supplier	die	Silicon(Si)	7440-21-3		0.268	mg	946996	16750
				supplier	metallisation	Aluminium(Al)	7429-90-5		0.004	mg	14134	250
				supplier	metallisation	Tungsten(W)	7440-33-7		0.003	mg	10601	188
				supplier	Passivation	Silicon nitride(SiN)	12033-89-5		0.001	mg	3534	63
				supplier	passivation	Silicon oxide	7631-86-9		0.007	mg	24735	438
Leadframe	M-004 Copper and its alloys	4.967	mg	supplier	alloy & coating	Copper(Cu)	7440-50-8		3.871	mg	779344	241938
				supplier	alloy & coating	Iron(Fe)	7439-89-6		0.085	mg	17113	5313
				supplier	alloy & coating	Phosphorus metal	7723-14-0		0.003	mg	604	188
				supplier	alloy & coating	Zinc(Zn)	7440-66-6		0.974	mg	196094	60875
				supplier	alloy & coating	Silver (Ag)	7440-22-4		0.034	mg	6845	2125
Die attach	M-015 Other organic materials	1.040	mg	supplier	glue	Silver	7440-22-4		0.841	mg	808654	52563
				supplier	glue	Acrylate monomer	Proprietary		0.097	mg	93269	6063
				supplier	glue	Acrylate oligomer	Proprietary		0.068	mg	65385	4250
				supplier	glue	Bismaleimide resin	35325-39-4		0.029	mg	27885	1813
				supplier	glue	Epoxy resin	29690-82-2		0.005	mg	4808	313
Bonding wires	M-004 Copper and its alloys	0.970	mg	supplier	wire	Copper (Cu)	7440-50-8		0.970	mg	1000000	60625
Encapsulation	M-015 Other organic materials	7.764	mg	supplier	mold compound	Epoxy Resin 1	29690-82-2		0.311	mg	40057	19438
				supplier	mold compound	Epoxy Resin 2	Proprietary		0.078	mg	10046	4875
				supplier	mold compound	Phenol Resin	25068-38-6		0.388	mg	49974	24250
				supplier	mold compound	Catalyst	Proprietary		0.039	mg	5023	2438
				supplier	mold compound	Carbon black	1333-86-4		0.008	mg	1030	500
				supplier	mold compound	Amorphous silica	60676-86-0		6.707	mg	863859	419188
				supplier	mold compound	Crystal silica	14808-60-7		0.233	mg	30010	14563
connections coating	Solder	0.970	mg	supplier	solder alloy	Tin (Sn)	7440-31-5		0.970	mg	1000000	60625